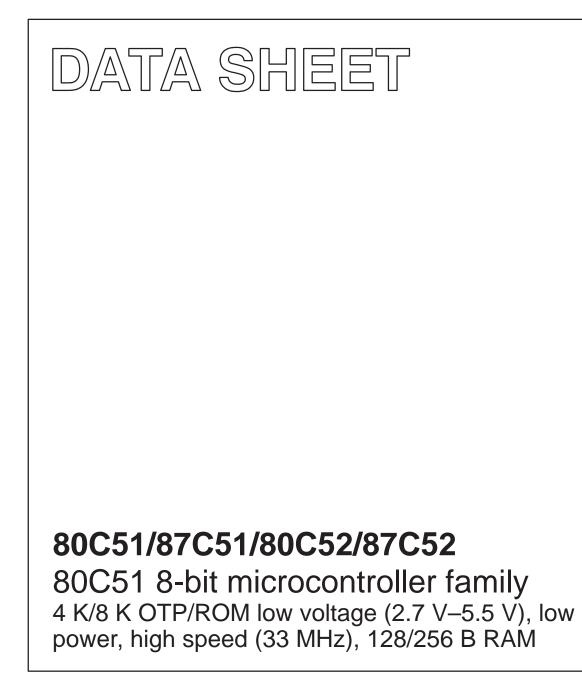
INTEGRATED CIRCUITS



Product specification Replaces datasheet 80C51/87C51/80C31 of 2000 Jan 20 2000 Aug 07





80C51 8-bit microcontroller family 4 K/8 K OTP/ROM low voltage (2.7 V–5.5 V), low power, high speed (33 MHz), 128/256 B RAM

DESCRIPTION

The Philips 80C51/87C51/80C52/87C52 is a high-performance static 80C51 design fabricated with Philips high-density CMOS technology with operation from 2.7 V to 5.5 V.

The 8xC51 and 8xC52 contain a 128×8 RAM and 256×8 RAM respectively, 32 I/O lines, three 16-bit counter/timers, a six-source, four-priority level nested interrupt structure, a serial I/O port for either multi-processor communications, I/O expansion or full duplex UART, and on-chip oscillator and clock circuits.

In addition, the device is a low power static design which offers a wide range of operating frequencies down to zero. Two software selectable modes of power reduction—idle mode and power-down mode are available. The idle mode freezes the CPU while allowing the RAM, timers, serial port, and interrupt system to continue functioning. The power-down mode saves the RAM contents but freezes the oscillator, causing all other chip functions to be inoperative. Since the design is static, the clock can be stopped without loss of user data and then the execution resumed from the point the clock was stopped.

SELECTION TABLE

For applications requiring more ROM and RAM, see the 8XC54/58 and 8XC51RA+/RB+/RC+/80C51RA+ data sheet.

Note: 80C31/80C32 is specified in separate data sheet.

ROM/EPROM Memory Size (X by 8)	RAM Size (X by 8) Programmable Timer Counter (PCA)		Hardware Watch Dog Timer							
80C31*/80C51/87C51										
0K/4K	128	No	No							
80C32*/80C52/87C52										
0K/8K/16K/32K	256	No	No							
80C51RA+/8XC5	51RA+/RB+/RC+	ŀ								
0K/8K/16K/32K	512	Yes	Yes							
8XC51RD+										
64K	1024	Yes	Yes							

FEATURES

- 8051 Central Processing Unit
- 4k × 8 ROM (80C51)
- 8k × 8 ROM (80C52)
- 128 × 8 RAM (80C51)
- 256 × 8 RAM (80C52)
- Three 16-bit counter/timers
- Boolean processor
- Full static operation
- Low voltage (2.7 V to 5.5 V@ 16 MHz) operation
- Memory addressing capability
 - 64k ROM and 64k RAM
- Power control modes:
 - Clock can be stopped and resumed
 - Idle mode
 - Power-down mode
- CMOS and TTL compatible
- TWO speed ranges at V_{CC} = 5 V
 - 0 to 16 MHz
 - 0 to 33 MHz
- Three package styles
- Extended temperature ranges
- Dual Data Pointers
- Security bits:
 - ROM (2 bits)
 - OTP/EPROM (3 bits)
- Encryption array 64 bytes
- 4 level priority interrupt
- 6 interrupt sources
- Four 8-bit I/O ports
- Full-duplex enhanced UART
 - Framing error detection
 - Automatic address recognition
- Programmable clock out
- Asynchronous port reset
- Low EMI (inhibit ALE and slew rate controlled outputs)
- Wake-up from Power Down by an external interrupt

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80C51 8-bit microcontroller family 4 K/8 K OTP/ROM low voltage (2.7 V–5.5 V), low power, high speed (33 MHz), 128/256 B RAM

80C51/87C51 ORDERING INFORMATION

	MEMORY SIZE 4K × 8	TEMPERATURE RANGE °C AND PACKAGE	VOLTAGE RANGE	FREQ. (MHz)	DWG. #	
ROM	P80C51SBPN	0 to x70 Dirat's Dual to line Darkers		0.1- 40	007400.4	
OTP	P87C51SBPN	0 to +70, Plastic Dual In-line Package	2.7 V to 5.5 V	0 to 16	SOT129-1	
ROM	P80C51SBAA	0 to 170 Pleatic Looded Chip Corrier		0 40 40	COT407.0	
OTP	P87C51SBAA	0 to +70, Plastic Leaded Chip Carrier	2.7 V to 5.5 V	0 to 16	SOT187-2	
ROM	P80C51SBBB	Ote v70 Pleatic Over Flat Park		0 40 40	COT207 0	
OTP	P87C51SBBB	0 to +70, Plastic Quad Flat Pack	2.7 V to 5.5 V	0 to 16	SOT307-2	
ROM	P80C51SFPN	40 to 205. Directio Dural to line Decision		0.1- 40	SOT129-1	
OTP	P87C51SFPN	-40 to +85, Plastic Dual In-line Package	2.7 V to 5.5 V	0 to 16	301129-1	
ROM	P80C51SFA A	40 to a 05. Direction land of this Operator		0.1- 40	007407.0	
OTP	P87C51SFA A	-40 to +85, Plastic Leaded Chip Carrier	2.7 V to 5.5 V	0 to 16	SOT187-2	
ROM	P80C51SFBB	40 to 195 Diastia Quad Flat Dask	2.7 V to 5.5 V	0 to 16	SOT307-2	
OTP	P87C51SFBB	-40 to +85, Plastic Quad Flat Pack	2.7 V 10 5.5 V	01016	501307-2	
ROM	P80C51UBAA	0 to 170 Plastic London Chip Corrier	5 V	0 to 33	SOT187-2	
OTP	P87C51UBAA	0 to +70, Plastic Leaded Chip Carrier	5 V	0 to 33	501187-2	
ROM	P80C51UBPN	0 to 170 Plantia Dual In line Deal and	5.14	0.45.00	COT400.4	
OTP	P87C51UBPN	0 to +70, Plastic Dual In-line Package	5 V	0 to 33	SOT129-1	
ROM	P80C51UFAA	40 to 195 Plastic Londod Chip Comiss	5.)(0 to 22	COT407.0	
OTP	P87C51UFAA	-40 to +85, Plastic Leaded Chip Carrier	5 V	0 to 33	SOT187-2	

PART NUMBER DERIVATION

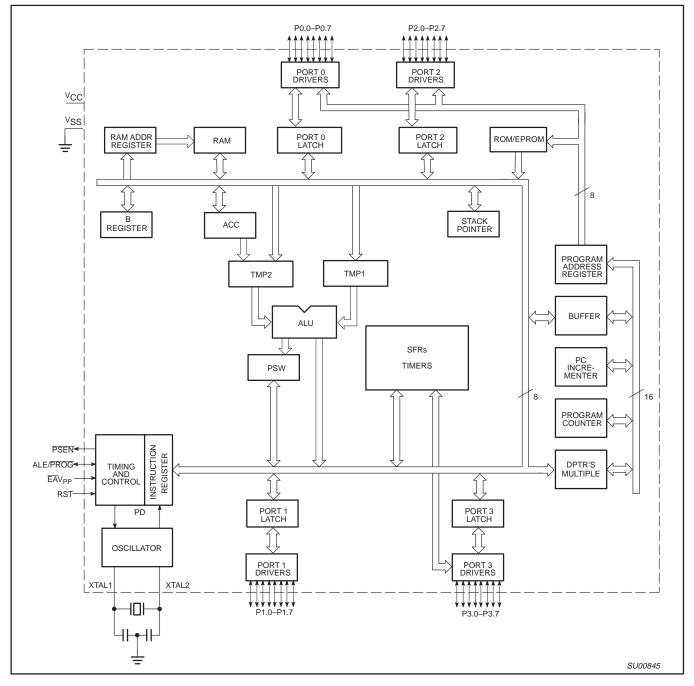
DEVICE NUMBER	DEVICE NUMBER	OPERATING FREQUENCY, MAX (S)	TEMPERATURE RANGE (B)	PACKAGE (AA)
ROM	P80C51	S = 16 MHz	$B = 0^{\circ} \text{ to } +70^{\circ}\text{C}$	AA = PLCC
ROM	P80C52	S = 16 MHz	$B = 0^{\circ}$ to +70°C	AA = PLCC
OTP	P87C51	U = 33 MHz	$F = -40^{\circ}C$ to $+85^{\circ}C$	BB = PQFP
OTP	P87C52	U = 33 MHz	$F = -40^{\circ}C$ to $+85^{\circ}C$	BB = PQFP

80C51 8-bit microcontroller family 4 K/8 K OTP/ROM low voltage (2.7 V–5.5 V), low power, high speed (33 MHz), 128/256 B RAM

80C52/87C52 ORDERING INFORMATION

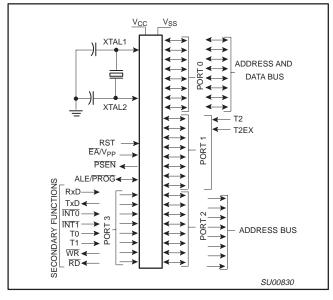
	MEMORY SIZE 8K × 8	TEMPERATURE RANGE °C AND PACKAGE	VOLTAGE RANGE	FREQ. (MHz)	DWG. #	
ROM	P80C52SBPN	0 to x70. Disatis Dual la line Deckare		0 to 16	SOT129-1	
OTP	P87C52SBPN	0 to +70, Plastic Dual In-line Package	2.7 V to 5.5 V	0 to 16	501129-1	
ROM	P80C52SBAA	0.45 + 70 Plantial coded Chip Corrier		0.45.40	007407.0	
OTP	P87C52SBAA	0 to +70, Plastic Leaded Chip Carrier	2.7 V to 5.5 V	0 to 16	SOT187-2	
ROM	P80C52SBBB	0.4 x 70 Plant's Over I Firt Part		0.1- 40	007007.0	
OTP	P87C52SBBB	0 to +70, Plastic Quad Flat Pack	2.7 V to 5.5 V	0 to 16	SOT307-2	
ROM	P80C52SFPN	40 to 205. Directio Dural to line Decision		0.1- 40	SOT129-1	
OTP	P87C52SFPN	-40 to +85, Plastic Dual In-line Package	2.7 V to 5.5 V	0 to 16	301129-1	
ROM	P80C52SFA A	40 to 205. Direction based of this Operator		0.1- 40	007407.0	
OTP	P87C52SFA A	-40 to +85, Plastic Leaded Chip Carrier	2.7 V to 5.5 V	0 to 16	SOT187-2	
ROM	P80C52SFBB	40 to 195 Plantin Quad Flat Pack	2.7 V to 5.5 V	0 to 16	SOT307-2	
OTP	P87C52SFBB	-40 to +85, Plastic Quad Flat Pack	2.7 V 10 5.5 V	01016	501307-2	
ROM	P80C52UBAA	0 to 170 Pleatial coded Chip Corrier	5.)(0 to 22	SOT187-2	
OTP	P87C52UBAA	0 to +70, Plastic Leaded Chip Carrier	5 V	0 to 33	501167-2	
ROM	P80C52UBPN	0 to 170 Plastic Dual la line Dealer in	5.1	0.45.00	007400.4	
OTP	P87C52UBPN	0 to +70, Plastic Dual In-line Package	5 V	0 to 33	SOT129-1	
ROM	P80C52UFA A	10 to 195 Plastic Londod Chip Comiss	5.)(0.45.22	COT497 0	
OTP	P87C52UFA A	-40 to +85, Plastic Leaded Chip Carrier	5 V	0 to 33	SOT187-2	

BLOCK DIAGRAM

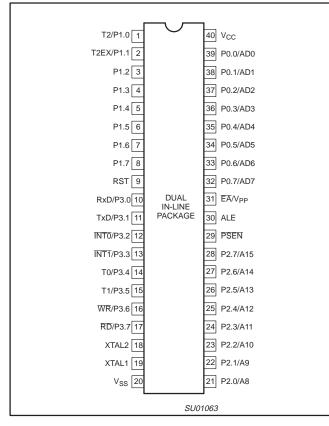


80C51/87C51/80C52/87C52

LOGIC SYMBOL



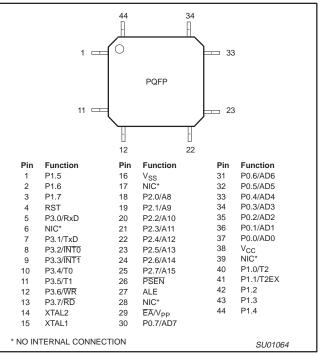
PIN CONFIGURATIONS



PLASTIC LEADED CHIP CARRIER PIN FUNCTIONS

		7	6		40	39	
Pin	Function		Pin	Function		Pin	Function
1	NIC*		16	P3.4/T0		31	P2.7/A15
2	P1.0/T2		17	P3.5/T1		32	PSEN
3	P1.1/T2EX		18	P3.6/WR		33	ALE
4	P1.2		19	P3.7/RD		34	NIC*
5	P1.3		20	XTAL2		35	EA/V _{PP}
6	P1.4		21	XTAL1		36	P0.7/AD7
7	P1.5		22	Vss		37	P0.6/AD6
8	P1.6		23	NIC*		38	P0.5/AD5
9	P1.7		24	P2.0/A8		39	P0.4/AD4
10	RST		25	P2.1/A9		40	P0.3/AD3
11	P3.0/RxD		26	P2.2/A10		41	P0.2/AD2
12	NIC*		27	P2.3/A11		42	P0.1/AD1
13	P3.1/TxD		28	P2.4/A12		43	P0.0/AD0
14	P3.2/INT0		29	P2.5/A13		44	V _{CC}
15	P3.3/INT1		30	P2.6/A14			
* NO IN	TERNAL COI	NNECTI	NC				SU01062

PLASTIC QUAD FLAT PACK PIN FUNCTIONS



80C51/87C51/80C52/87C52

PIN DESCRIPTIONS

	PIN NUMBER		NUMBER						
MNEMONIC	DIP	LCC	QFP	TYPE	NAME AND FUNCTION				
V _{SS}	20	22	16	1	Ground: 0 V reference.				
V _{CC}	40	44	38	I.	Power Supply: This is the power supply voltage for normal, idle, and power-down operation.				
P0.0-0.7	39–32	43–36	37–30	I/O	Port 0: Port 0 is an open-drain, bidirectional I/O port with Schmitt trigger inputs. Port 0 pins that have 1s written to them float and can be used as high-impedance inputs. Port 0 is also the multiplexed low-order address and data bus during accesses to external program and data memory. In this application, it uses strong internal pull-ups when emitting 1s. Port 0 also outputs the code bytes during program verification and received code bytes during EPROM programming. External pull-ups are required during program verification.				
P1.0–P1.7	1–8	2–9	40–44, 1–3	I/O	Port 1: Port 1 is an 8-bit bidirectional I/O port with internal pull-ups and Schmitt trigger inputs. Port 1 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, port 1 pins that are externally pulled low will source current because of the internal pull-ups. (See DC Electrical Characteristics: I_{IL}). Port 1 also receives the low-order address byte during program memory verification. Alternate functions for Port 1 include:				
	1 2	2 3	40 41	I/O I	T2 (P1.0): Timer/Counter 2 external count input/clockout (see Programmable Clock-Out) T2EX (P1.1): Timer/Counter 2 Reload/Capture/Direction control				
P2.0-P2.7	21–28	24–31	18–25	I/O	Port 2: Port 2 is an 8-bit bidirectional I/O port with internal pull-ups and Schmitt trigger inputs. Port 2 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, port 2 pins that are externally being pulled low will source current because of the internal pull-ups. (See DC Electrical Characteristics: I _{IL}). Port 2 emits the high-order address byte during fetches from external program memory and during accesses to external data memory that use 16-bit addresses (MOVX @DPTR). In this application, it uses strong internal pull-ups when emitting 1s. During accesses to external data memory that use 8-bit addresses (MOV @Ri), port 2 emits the contents of the P2 special function register. Some Port 2 pins receive the high order address bits during EPROM programming and verification.				
P3.0–P3.7	10–17	11, 13–19	5, 7–13	I/O	Port 3: Port 3 is an 8-bit bidirectional I/O port with internal pull-ups and Schmitt trigger inputs. Port 3 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, port 3 pins that are externally being pulled low will source current because of the pull-ups. (See DC Electrical Characteristics: I _{IL}). Port 3 also serves the special features of the 80C51 family, as listed below:				
	10	11	5	1	RxD (P3.0): Serial input port				
	11	13	7	0	TxD (P3.1): Serial output port				
	12	14	8	I	INTO (P3.2): External interrupt				
	13	15	9	I.	INT1 (P3.3): External interrupt				
	14	16	10	I.	T0 (P3.4): Timer 0 external input				
	15	17	11	I.	T1 (P3.5): Timer 1 external input				
	16	18	12	0	WR (P3.6): External data memory write strobe				
	17	19	13	0	RD (P3.7): External data memory read strobe				
RST	9	10	4	I	Reset: A high on this pin for two machine cycles while the oscillator is running, resets the device. An internal diffused resistor to V_{SS} permits a power-on reset using only an external capacitor to V_{CC} .				
ALE/PROG	30	33	27	0	Address Latch Enable/Program Pulse: Output pulse for latching the low byte of the address during an access to external memory. In normal operation, ALE is emitted at a constant rate of 1/6 the oscillator frequency, and can be used for external timing or clocking. Note that one ALE pulse is skipped during each access to external data memory. This pin is also the program pulse input (PROG) during EPROM programming. ALE can be disabled by setting SFR auxiliary.0. With this bit set, ALE will be active only during a MOVX instruction.				
PSEN	29	32	26	0	Program Store Enable: The read strobe to external program memory. When the device is executing code from the external program memory, PSEN is activated twice each machine cycle, except that two PSEN activations are skipped during each access to external data memory. PSEN is not activated during fetches from internal program memory.				
EA/V _{PP}	31	35	29	I	External Access Enable/Programming Supply Voltage: \overline{EA} must be externally held low to enable the device to fetch code from external program memory locations 0000H to 0FFFH. If \overline{EA} is held high, the device executes from internal program memory unless the program counter contains an address greater than the on-chip ROM/OTP. This pin also receives the 12.75 V programming supply voltage (V _{PP}) during EPROM programming. If security bit 1 is programmed, \overline{EA} will be internally latched on Reset.				
XTAL1	19	21	15	I	Crystal 1: Input to the inverting oscillator amplifier and input to the internal clock generator circuits.				

NOTE:

To avoid "latch-up" effect at power-on, the voltage on any pin at any time must not be higher than V_{CC} + 0.5 V or V_{SS} – 0.5 V, respectively.

80C51/87C51/80C52/87C52

Table 1. 80C51/87C51/80C52/87C52 Special Function Registers

SYMBOL	DESCRIPTION	DIRECT ADDRESS	BIT A MSB		, SYMBOI	L, OR ALT	ERNATIV		FUNCTIC	DN LSB	RESET VALUE
ACC*	Accumulator	E0H	E7	E6	E5	E4	E3	E2	E1	E0	00H
AUXR#	Auxiliary	8EH	-	-	-	-	-	-	-	AO	xxxxxxx0B
AUXR1#	Auxiliary 1	A2H	-	-	-	LPEP ²	WUPD	0	-	DPS	xxx000x0B
B*	B register	F0H	F7	F6	F5	F4	F3	F2	F1	F0	00Н
DPTR:	Data Pointer (2 bytes)										
DPH	Data Pointer High	83H									00H
DPL	Data Pointer Low	82H									00H
			AF	AE	AD	AC	AB	AA	A9	A8	
IE*	Interrupt Enable	A8H	EA	-	ET2	ES	ET1	EX1	ET0	EX0	0x000000B
			BF	BE	BD	BC	BB	BA	B9	B8	1
IP*	Interrupt Priority	B8H	_	-	PT2	PS	PT1	PX1	PT0	PX0	xx000000B
			B7	B6	B5	B4	B3	B2	B1	B0	1
IPH#	Interrupt Priority High	B7H	_	_	PT2H	PSH	PT1H	PX1H	PTOH	PX0H	xx000000B
	interrupt i nonty i light	5/11	87	86	85	84	83	82	81	80	
P0*	Port 0	80H	AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0	FFH
10	1 010 0	0011	97	96	95	94	93	92	91	90	4 ' ' ' '
P1*	Port 1	90H	-	- 30	-		-	-	T2EX	30 T2	FFH
PI	POILT	900	 A7	 A6	 A5	 A4	– A3	- A2	A1	A0	
D0*	Dart 0	A 01 1									
P2*	Port 2	A0H	AD15	AD14	AD13	AD12	AD11	AD10	AD9	AD8	FFH
			B7	B6	B5	B4	B3	B2	B1	B0	l
P3*	Port 3	B0H	RD	WR	T1	T0	INT1	INTO	TxD	RxD	FFH
PCON# ¹	Power Control	87H	SMOD1	SMOD0	-	POF	GF1	GF0	PD	IDL	00xx0000B
			D7	D6	D5	D4	D3	D2	D1	D0	1
PSW*	Program Status Word	D0H	CY	AC	F0	RS1	RS0	OV	-	Р	000000x0B
RACAP2H#	Timer 2 Capture High	СВН									00H
RACAP2L#	Timer 2 Capture Low	CAH									00H
SADDR#	Slave Address	A9H									00H
SADEN#	Slave Address Mask	B9H									00H
SBUF	Serial Data Buffer	99H									xxxxxxxB
			9F	9E	9D	9C	9B	9A	99	98	
SCON*	Serial Control	98H	SM0/FE	SM1	SM2	REN	TB8	RB8	TI	RI	00H
SP	Stack Pointer	81H		-	-		-				07H
0.		•	8F	8E	8D	8C	8B	8A	89	88	
TCON*	Timer Control	88H	TF1	TR1	TF0	TR0	IE1	IT1	IE0	ITO	00H
1001		0011	CF	CE	CD	CC	CB	CA	C9	C8	
T2CON*	Timer 2 Control	C8H		EXF2			EXEN2	TR2			00H
T2MOD#	Timer 2 Mode Control	C9H	TF2 -		RCLK	TCLK		-	C/T2 T2OE	CP/RL2 DCEN	xxxxxx00B
TZMOD# TH0	Timer 2 Mode Control	8CH		_	-	-	-	_	120E	DUEN	00H
TH0 TH1	Timer High 1	8DH									00H
TH2#	Timer High 2	CDH									00H
	e e e e e e e e e e e e e e e e e e e										00H
	Timer Low 0	А КА Н									
TL0	Timer Low 0 Timer Low 1	8AH 8BH									
	Timer Low 0 Timer Low 1 Timer Low 2	8AH 8BH CCH									00H 00H

NOTE:

Unused register bits that are not defined should not be set by the user's program. If violated, the device could function incorrectly. * SFRs are bit addressable.

SFRs are modified from or added to the 80C51 SFRs.

Reserved bits.

1. Reset value depends on reset source.

2. LPEP - Low Power EPROM operation (OTP/EPROM only)

OSCILLATOR CHARACTERISTICS

XTAL1 and XTAL2 are the input and output, respectively, of an inverting amplifier. The pins can be configured for use as an on-chip oscillator, as shown in the logic symbol.

To drive the device from an external clock source, XTAL1 should be driven while XTAL2 is left unconnected. There are no requirements on the duty cycle of the external clock signal, because the input to the internal clock circuitry is through a divide-by-two flip-flop. However, minimum and maximum high and low times specified in the data sheet must be observed.

Reset

A reset is accomplished by holding the RST pin high for at least two machine cycles (24 oscillator periods), while the oscillator is running. To insure a good power-up reset, the RST pin must be high long enough to allow the oscillator time to start up (normally a few milliseconds) plus two machine cycles.

Stop Clock Mode

The static design enables the clock speed to be reduced down to 0 MHz (stopped). When the oscillator is stopped, the RAM and Special Function Registers retain their values. This mode allows step-by-step utilization and permits reduced system power consumption by lowering the clock frequency down to any value. For lowest power consumption the Power Down mode is suggested.

Idle Mode

In idle mode (see Table 2), the CPU puts itself to sleep while all of the on-chip peripherals stay active. The instruction to invoke the idle mode is the last instruction executed in the normal operating mode before the idle mode is activated. The CPU contents, the on-chip RAM, and all of the special function registers remain intact during this mode. The idle mode can be terminated either by any enabled interrupt (at which time the process is picked up at the interrupt service routine and continued), or by a hardware reset which starts the processor in the same manner as a power-on reset.

Power-Down Mode

To save even more power, a Power Down mode (see Table 2) can be invoked by software. In this mode, the oscillator is stopped and the instruction that invoked Power Down is the last instruction executed. The on-chip RAM and Special Function Registers retain their values down to 2.0 V and care must be taken to return V_{CC} to the minimum specified operating voltages before the Power Down Mode is terminated.

For the 87C51 and 80C51 either a hardware reset or external interrupt can be used to exit from Power Down. Reset redefines all

80C51/87C51/80C52/87C52

the SFRs but does not change the on-chip RAM. An external interrupt allows both the SFRs and the on-chip RAM to retain their values. WUPD (AUXR1.3–Wakeup from Power Down) enables or disables the wakeup from power down with external interrupt. Where:

WUPD = 0 Disable WUPD = 1 Enable

To properly terminate Power Down the reset or external interrupt should not be executed before V_{CC} is restored to its normal operating level and must be held active long enough for the oscillator to restart and stabilize (normally less than 10 ms).

With an external interrupt, INT0 or INT1 must be enabled and configured as level-sensitive. Holding the pin low restarts the oscillator but bringing the pin back high completes the exit. Once the interrupt is serviced, the next instruction to be executed after RETI will be the one following the instruction that put the device into Power Down.

LPEP

The eprom array contains some analog circuits that are not required when V_{CC} is less than 4 V, but are required for a V_{CC} greater than 4 V. The LPEP bit (AUXR.4), when set, will powerdown these analog circuits resulting in a reduced supply current. This bit should be set ONLY for applications that operate at a V_{CC} less than 4 V.

Design Consideration

• When the idle mode is terminated by a hardware reset, the device normally resumes program execution, from where it left off, up to two machine cycles before the internal reset algorithm takes control. On-chip hardware inhibits access to internal RAM in this event, but access to the port pins is not inhibited. To eliminate the possibility of an unexpected write when Idle is terminated by reset, the instruction following the one that invokes Idle should not be one that writes to a port pin or to external memory.

ONCE™ Mode

The ONCE ("On-Circuit Emulation") Mode facilitates testing and debugging of systems without the device having to be removed from the circuit. The ONCE Mode is invoked by:

- 1. Pull ALE low while the device is in reset and PSEN is high;
- 2. Hold ALE low as RST is deactivated.

While the device is in ONCE Mode, the Port 0 pins go into a float state, and the other port pins and ALE and PSEN are weakly pulled high. The oscillator circuit remains active. While the device is in this mode, an emulator or test CPU can be used to drive the circuit. Normal operation is restored when a normal reset is applied.

 Table 2. External Pin Status During Idle and Power-Down Modes

MODE	PROGRAM MEMORY	ALE	PSEN	PORT 0	PORT 1	PORT 2	PORT 3
Idle	Internal	1	1	Data	Data	Data	Data
Idle	External	1	1	Float	Data	Address	Data
Power-down	Internal	0	0	Data	Data	Data	Data
Power-down	External	0	0	Float	Data	Data	Data

Programmable Clock-Out

A 50% duty cycle clock can be programmed to come out on P1.0. This pin, besides being a regular I/O pin, has two alternate functions. It can be programmed:

- 1. to input the external clock for Timer/Counter 2, or
- to output a 50% duty cycle clock ranging from 61 Hz to 4 MHz at a 16 MHz operating frequency.

To configure the Timer/Counter 2 as a clock generator, bit C/T2 (in T2CON) must be cleared and bit T20E in T2MOD must be set. Bit TR2 (T2CON.2) also must be set to start the timer.

The Clock-Out frequency depends on the oscillator frequency and the reload value of Timer 2 capture registers (RCAP2H, RCAP2L) as shown in this equation:

```
\frac{\text{Oscillator Frequency}}{4 \times (65536 - \text{RCAP2H}, \text{RCAP2L})}
```

Where:

(RCAP2H,RCAP2L) = the content of RCAP2H and RCAP2L taken as a 16-bit unsigned integer.

In the Clock-Out mode Timer 2 roll-overs will not generate an interrupt. This is similar to when it is used as a baud-rate generator. It is possible to use Timer 2 as a baud-rate generator and a clock generator simultaneously. Note, however, that the baud-rate and the Clock-Out frequency will be the same.

TIMER 2 OPERATION

Timer 2

Timer 2 is a 16-bit Timer/Counter which can operate as either an event timer or an event counter, as selected by $C/\overline{12}^*$ in the special function register T2CON (see Figure 1). Timer 2 has three operating modes:Capture, Auto-reload (up or down counting) ,and Baud Rate Generator, which are selected by bits in the T2CON as shown in Table 3.

Capture Mode

In the capture mode there are two options which are selected by bit EXEN2 in T2CON. If EXEN2=0, then timer 2 is a 16-bit timer or counter (as selected by C/T2* in T2CON) which, upon overflowing sets bit TF2, the timer 2 overflow bit. This bit can be used to generate an interrupt (by enabling the Timer 2 interrupt bit in the IE register). If EXEN2= 1, Timer 2 operates as described above, but with the added feature that a 1- to -0 transition at external input T2EX causes the current value in the Timer 2 registers, TL2 and

TH2, to be captured into registers RCAP2L and RCAP2H, respectively. In addition, the transition at T2EX causes bit EXF2 in T2CON to be set, and EXF2 like TF2 can generate an interrupt (which vectors to the same location as Timer 2 overflow interrupt. The Timer 2 interrupt service routine can interrogate TF2 and EXF2 to determine which event caused the interrupt). The capture mode is illustrated in Figure 2 (There is no reload value for TL2 and TH2 in this mode. Even when a capture event occurs from T2EX, the counter keeps on counting T2EX pin transitions or osc/12 pulses.).

Auto-Reload Mode (Up or Down Counter)

In the 16-bit auto-reload mode, Timer 2 can be configured (as either a timer or counter (C/T2* in T2CON)) then programmed to count up or down. The counting direction is determined by bit DCEN (Down Counter Enable) which is located in the T2MOD register (see Figure 3). When reset is applied the DCEN=0 which means Timer 2 will default to counting up. If DCEN bit is set, Timer 2 can count up or down depending on the value of the T2EX pin.

Figure 4 shows Timer 2 which will count up automatically since DCEN=0. In this mode there are two options selected by bit EXEN2 in T2CON register. If EXEN2=0, then Timer 2 counts up to 0FFFFH and sets the TF2 (Overflow Flag) bit upon overflow. This causes the Timer 2 registers to be reloaded with the 16-bit value in RCAP2L and RCAP2H. The values in RCAP2L and RCAP2H are preset by software means.

If EXEN2=1, then a 16-bit reload can be triggered either by an overflow or by a 1-to-0 transition at input T2EX. This transition also sets the EXF2 bit. The Timer 2 interrupt, if enabled, can be generated when either TF2 or EXF2 are 1.

In Figure 5 DCEN=1 which enables Timer 2 to count up or down. This mode allows pin T2EX to control the direction of count. When a logic 1 is applied at pin T2EX Timer 2 will count up. Timer 2 will overflow at 0FFFFH and set the TF2 flag, which can then generate an interrupt, if the interrupt is enabled. This timer overflow also causes the 16–bit value in RCAP2L and RCAP2H to be reloaded into the timer registers TL2 and TH2.

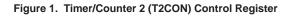
When a logic 0 is applied at pin T2EX this causes Timer 2 to count down. The timer will underflow when TL2 and TH2 become equal to the value stored in RCAP2L and RCAP2H. Timer 2 underflow sets the TF2 flag and causes 0FFFFH to be reloaded into the timer registers TL2 and TH2.

The external flag EXF2 toggles when Timer 2 underflows or overflows. This EXF2 bit can be used as a 17th bit of resolution if needed. The EXF2 flag does not generate an interrupt in this mode of operation.

RCLK + TCLK	CP/RL2	TR2	MODE
0	0	1	16-bit Auto-reload
0	1	1	16-bit Capture
1	Х	1	Baud rate generator
Х	Х	0	(off)

Table 3. Timer 2 Operating Modes

	(M	SB)					-	-	(LSB)	
		TF2	EXF2	RCLK	TCLK	EXEN2	TR2	C/T2	CP/RL2	
Symbol	Position	n Nai	me and Sig	nificance						
TF2	T2CON.		Timer 2 overflow flag set by a Timer 2 overflow and must be cleared by software. TF2 will not be set when either RCLK or TCLK = 1.							
EXF2	T2CON.	EXI	Timer 2 external flag set when either a capture or reload is caused by a negative transition on T2EX and $EXEN2 = 1$. When Timer 2 interrupt is enabled, $EXF2 = 1$ will cause the CPU to vector to the Timer 2 interrupt routine. $EXF2$ must be cleared by software. $EXF2$ does not cause an interrupt in up/down counter mode (DCEN = 1).							
RCLK	T2CON.								ow pulses for eceive clock.	its receive clock
TCLK	T2CON.								ow pulses fo transmit cloc	r its transmit clock <.
EXEN2	T2CON.	trar		EX if Timer						of a negative ses Timer 2 to
TR2	T2CON.	2 Sta	rt/stop contr	ol for Timer	2. A logic 1	starts the ti	mer.			
C/T2	T2CON.	1 Tim	Start/stop control for Timer 2. A logic 1 starts the timer. Timer or counter select. (Timer 2) 0 = Internal timer (OSC/12) 1 = External event counter (falling edge triggered).							
CP/RL2	T2CON.	clea	ared, auto-re	eloads will o nen either R	ccur either	with Timer 2	overflows of	or negative t	ransitions at	XEN2 = 1. When T2EX when ed to auto-reload



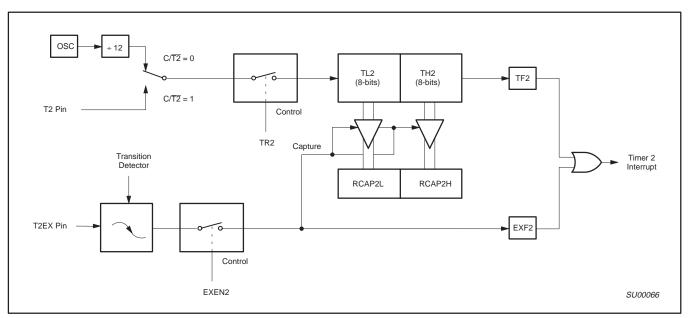
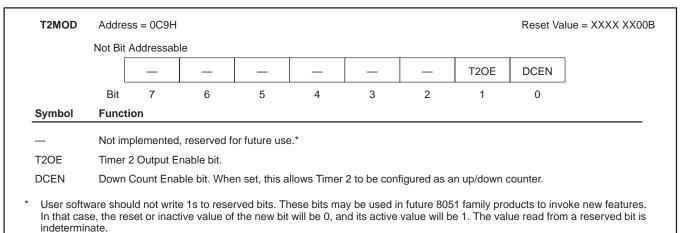
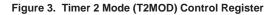


Figure 2. Timer 2 in Capture Mode

80C51/87C51/80C52/87C52



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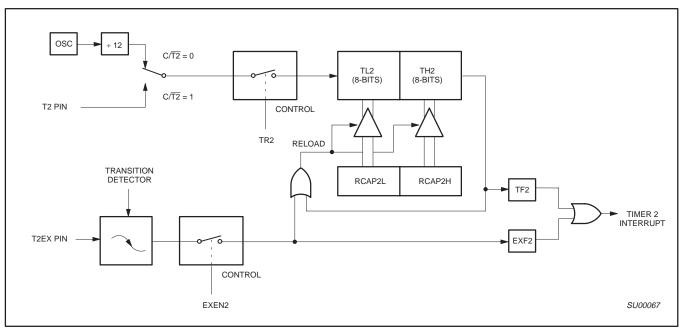


Figure 4. Timer 2 in Auto-Reload Mode (DCEN = 0)

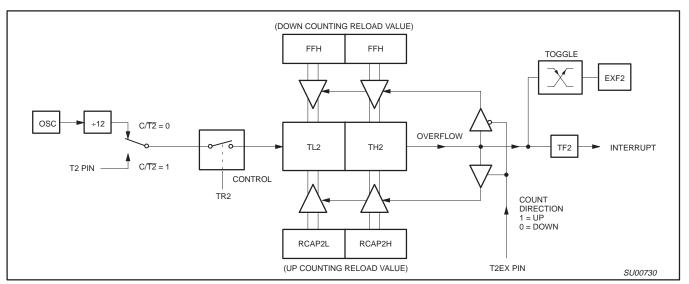


Figure 5. Timer 2 Auto Reload Mode (DCEN = 1)

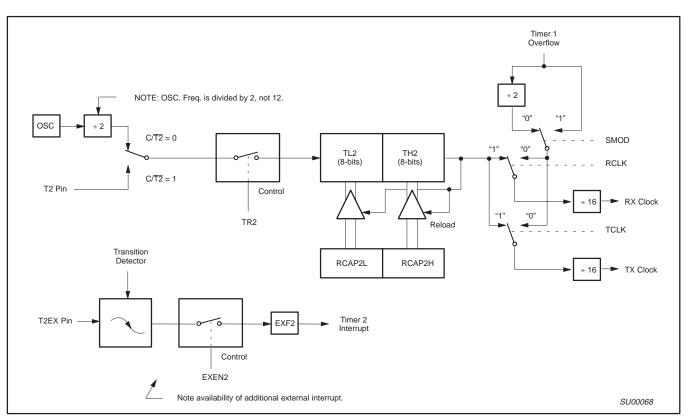


Figure 6. Timer 2 in Baud Rate Generator Mode

Baud Rate Generator Mode

Bits TCLK and/or RCLK in T2CON (Table 3) allow the serial port transmit and receive baud rates to be derived from either Timer 1 or Timer 2. When TCLK= 0, Timer 1 is used as the serial port transmit baud rate generator. When TCLK= 1, Timer 2 is used as the serial port transmit baud rate generator. RCLK has the same effect for the serial port receive baud rate. With these two bits, the serial port can have different receive and transmit baud rates – one generated by Timer 1, the other by Timer 2.

Figure 6 shows the Timer 2 in baud rate generation mode. The baud rate generation mode is like the auto-reload mode, in that a rollover in TH2 causes the Timer 2 registers to be reloaded with the 16-bit value in registers RCAP2H and RCAP2L, which are preset by software.

The baud rates in modes 1 and 3 are determined by Timer 2's overflow rate given below:

Modes 1 and 3 Baud Rates =
$$\frac{\text{Timer 2 Overflow Rate}}{16}$$

The timer can be configured for either "timer" or "counter" operation. In many applications, it is configured for "timer" operation (C/ $T2^*=0$). Timer operation is different for Timer 2 when it is being used as a baud rate generator.

Usually, as a timer it would increment every machine cycle (i.e., 1/12 the oscillator frequency). As a baud rate generator, it increments every state time (i.e., 1/2 the oscillator frequency). Thus the baud rate formula is as follows:

Modes 1 and 3 Baud Rates =

Oscillator Frequency [32 × [65536 - (RCAP2H, RCAP2L)]]

Where: (RCAP2H, RCAP2L)= The content of RCAP2H and RCAP2L taken as a 16-bit unsigned integer.

The Timer 2 as a baud rate generator mode shown in Figure 6, is valid only if RCLK and/or TCLK = 1 in T2CON register. Note that a rollover in TH2 does not set TF2, and will not generate an interrupt. Thus, the Timer 2 interrupt does not have to be disabled when Timer 2 is in the baud rate generator mode. Also if the EXEN2 (T2 external enable flag) is set, a 1-to-0 transition in T2EX (Timer/counter 2 trigger input) will set EXF2 (T2 external flag) but will not cause a reload from (RCAP2H, RCAP2L) to (TH2,TL2). Therefore when Timer 2 is in use as a baud rate generator, T2EX can be used as an additional external interrupt, if needed.

When Timer 2 is in the baud rate generator mode, one should not try to read or write TH2 and TL2. As a baud rate generator, Timer 2 is incremented every state time (osc/2) or asynchronously from pin T2;

80C51/87C51/80C52/87C52

under these conditions, a read or write of TH2 or TL2 may not be accurate. The RCAP2 registers may be read, but should not be written to, because a write might overlap a reload and cause write and/or reload errors. The timer should be turned off (clear TR2) before accessing the Timer 2 or RCAP2 registers.

Table 4 shows commonly used baud rates and how they can be obtained from Timer 2.

Baud Rate	Oco Erog	Tim	er 2
Baud Kale	Osc Freq	RCAP2H	RCAP2L
375 K	12 MHz	FF	FF
9.6 K	12 MHz	FF	D9
2.8 K	12 MHz	FF	B2
2.4 K	12 MHz	FF	64
1.2 K	12 MHz	FE	C8
300	12 MHz	FB	1E
110	12 MHz	F2	AF
300	6 MHz	FD	8F
110	6 MHz	F9	57

Table 4. Timer 2 Generated Commonly Used Baud Rates

Summary Of Baud Rate Equations

Timer 2 is in baud rate generating mode. If Timer 2 is being clocked through pin T2(P1.0) the baud rate is:

Baud Rate = $\frac{\text{Timer 2 Overflow Rate}}{16}$

If Timer 2 is being clocked internally, the baud rate is:

Baud Rate =
$$\frac{f_{OSC}}{[32 \times [65536 - (RCAP2H, RCAP2L)]]}$$

Where f_{OSC}= Oscillator Frequency

To obtain the reload value for RCAP2H and RCAP2L, the above equation can be rewritten as:

$$RCAP2H, RCAP2L = 65536 - \left(\frac{f_{OSC}}{32 \times Baud Rate}\right)$$

Timer/Counter 2 Set-up

Except for the baud rate generator mode, the values given for T2CON do not include the setting of the TR2 bit. Therefore, bit TR2 must be set, separately, to turn the timer on. See Table 5 for set-up of Timer 2 as a timer. Also see Table 6 for set-up of Timer 2 as a counter.

80C51/87C51/80C52/87C52

Table 5. Timer 2 as a Timer

MODE	T20	ON
MODE	INTERNAL CONTROL (Note 1)	EXTERNAL CONTROL (Note 2)
16-bit Auto-Reload	00H	08H
16-bit Capture	01H	09H
Baud rate generator receive and transmit same baud rate	34H	36H
Receive only	24H	26H
Transmit only	14H	16H

Table 6. Timer 2 as a Counter

MODE	TMOD					
MODE	INTERNAL CONTROL (Note 1)	EXTERNAL CONTROL (Note 2)				
16-bit	02H	0AH				
Auto-Reload	03H	0BH				

NOTES:

1. Capture/reload occurs only on timer/counter overflow.

2. Capture/reload occurs on timer/counter overflow and a 1-to-0 transition on T2EX (P1.1) pin except when Timer 2 is used in the baud rate generator mode.

Enhanced UART

The UART operates in all of the usual modes that are described in the first section of *Data Handbook IC20, 80C51-Based 8-Bit Microcontrollers.* In addition the UART can perform framing error detect by looking for missing stop bits, and automatic address recognition. The UART also fully supports multiprocessor communication.

When used for framing error detect the UART looks for missing stop bits in the communication. A missing bit will set the FE bit in the SCON register. The FE bit shares the SCON.7 bit with SM0 and the function of SCON.7 is determined by PCON.6 (SMOD0) (see Figure 7). If SMOD0 is set then SCON.7 functions as FE. SCON.7 functions as SM0 when SMOD0 is cleared. When used as FE SCON.7 can only be cleared by software. Refer to Figure 8.

Automatic Address Recognition

Automatic Address Recognition is a feature which allows the UART to recognize certain addresses in the serial bit stream by using hardware to make the comparisons. This feature saves a great deal of software overhead by eliminating the need for the software to examine every serial address which passes by the serial port. This feature is enabled by setting the SM2 bit in SCON. In the 9 bit UART modes, mode 2 and mode 3, the Receive Interrupt flag (RI) will be automatically set when the received byte contains either the "Given" address or the "Broadcast" address. The 9 bit mode requires that the 9th information bit is a 1 to indicate that the received information is an address and not data. Automatic address recognition is shown in Figure 9.

The 8 bit mode is called Mode 1. In this mode the RI flag will be set if SM2 is enabled and the information received has a valid stop bit following the 8 address bits and the information is either a Given or Broadcast address.

Mode 0 is the Shift Register mode and SM2 is ignored.

Using the Automatic Address Recognition feature allows a master to selectively communicate with one or more slaves by invoking the Given slave address or addresses. All of the slaves may be contacted by using the Broadcast address. Two special Function Registers are used to define the slave's address, SADDR, and the address mask, SADEN. SADEN is used to define which bits in the

SADDR are to b used and which bits are "don't care". The SADEN mask can be logically ANDed with the SADDR to create the "Given" address which the master will use for addressing each of the slaves. Use of the Given address allows multiple slaves to be recognized while excluding others. The following examples will help to show the versatility of this scheme:

Slave 0	SADDR SADEN Given	1111	0000 <u>1101</u> 00X0
Slave 1	SADDR SADEN Given	1111	0000 <u>1110</u> 000X

In the above example SADDR is the same and the SADEN data is used to differentiate between the two slaves. Slave 0 requires a 0 in bit 0 and it ignores bit 1. Slave 1 requires a 0 in bit 1 and bit 0 is ignored. A unique address for Slave 0 would be 1100 0010 since slave 1 requires a 0 in bit 1. A unique address for slave 1 would be 1100 0001 since a 1 in bit 0 will exclude slave 0. Both slaves can be selected at the same time by an address which has bit 0 = 0 (for slave 0) and bit 1 = 0 (for slave 1). Thus, both could be addressed with 1100 0000.

In a more complex system the following could be used to select slaves 1 and 2 while excluding slave 0:

Slave 0	SADDR SADEN Given	= = =	1100 <u>1111</u> 1100	
Slave 1	SADDR SADEN Given	= = =	1110 <u>1111</u> 1110	
Slave 2	SADDR SADEN Given	= = =	1110 <u>1111</u> 1110	0000 <u>1100</u> 00XX

In the above example the differentiation among the 3 slaves is in the lower 3 address bits. Slave 0 requires that bit 0 = 0 and it can be uniquely addressed by 1110 0110. Slave 1 requires that bit 1 = 0 and it can be uniquely addressed by 1110 and 0101. Slave 2 requires that bit 2 = 0 and its unique address is 1110 0011. To select Slaves 0

and 1 and exclude Slave 2 use address 1110 0100, since it is necessary to make bit 2 = 1 to exclude slave 2.

The Broadcast Address for each slave is created by taking the logical OR of SADDR and SADEN. Zeros in this result are trended as don't-cares. In most cases, interpreting the don't-cares as ones, the broadcast address will be FF hexadecimal.

Upon reset SADDR (SFR address 0A9H) and SADEN (SFR address 0B9H) are leaded with 0s. This produces a given address of all "don't cares" as well as a Broadcast address of all "don't cares". This effectively disables the Automatic Addressing mode and allows the microcontroller to use standard 80C51 type UART drivers which do not make use of this feature.

80C51/87C51/80C52/87C52

		SCON Add	1033 - 3011							Reset Value = 0000 0000B
	BIT AC	dressable	SM1	SM2	REN	TB8	RB8	ті	RI	7
	Bit:	7	6	5	4	3	2	1	0	
		(SMOD0 = 0)	0/1)*							
Symbol	Fun	ction								
FE		ning Error bit es but shoul								it is not cleared by valid e FE bit.
SM0	Seria	al Port Mode	Bit 0, (SMC	DD0 must :	= 0 to acce	ss bit SM0)				
SM1	Seria SM0	al Port Mode SM1	Bit 1 Mode	Descr	iption	Baud Rate	**			
	0	0	0	shift re	egister	f _{OSC} /12				
	0	1	1	8-bit U		variable				
	1 1	0 1	2 3	9-bit U 9-bit U		f _{OSC} /64 or t variable	OSC/32			
SM2	rece In M	ived 9th data	a bit (RB8) i: 2 = 1 then R	s 1, indicat	ing an add e activated	ress, and th I unless a va	e received	byte is a G	iven or Bro	ot be set unless the badcast Address. e received byte is a
REN	Enal	oles serial re	ception. Se	t by softwa	re to enab	le reception.	Clear by s	oftware to	disable rec	ception.
TB8	The	9th data bit 1	that will be t	ransmitted	in Modes	2 and 3. Set	or clear by	y software a	as desired.	
RB8		odes 2 and 3 ode 0, RB8 i		ata bit that	was receiv	ed. In Mode	1, if SM2 =	= 0, RB8 is	the stop b	it that was received.
ті		smit interrup r modes, in a						Mode 0, or a	at the begi	nning of the stop bit in the
	-	eive interrup								ough the stop bit time in
RI		ther modes	, in any seria	al receptio	n (except s	ee Sivi2). Ivi	ust be clea	red by soft	ware.	

Figure 7. SCON: Serial Port Control Register

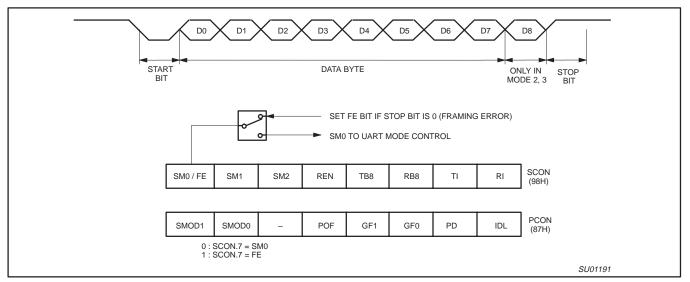


Figure 8. UART Framing Error Detection

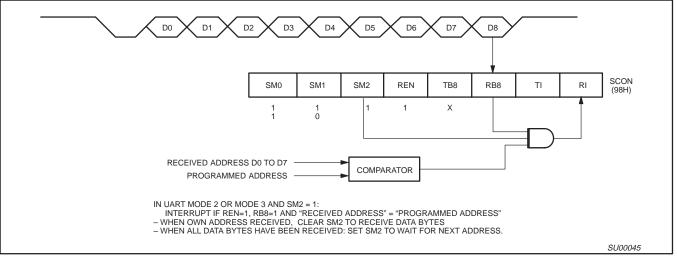


Figure 9. UART Multiprocessor Communication, Automatic Address Recognition

80C51/87C51/80C52/87C52

Interrupt Priority Structure

The 80C51/87C51 and 80C52/87C52 have a 6-source four-level interrupt structure. They are the IE, IP and IPH. (See Figures 10, 11, and 12.) The IPH (Interrupt Priority High) register that makes the four-level interrupt structure possible. The IPH is located at SFR address B7H. The structure of the IPH register and a description of its bits is shown in Figure 12.

The function of the IPH SFR is simple and when combined with the IP SFR determines the priority of each interrupt. The priority of each interrupt is determined as shown in the following table:

PRIORI	TY BITS	
IPH.x	IP.x	
0	0	Level 0 (lowest priority)
0	1	Level 1
1	0	Level 2
1	1	Level 3 (highest priority)

An interrupt will be serviced as long as an interrupt of equal or higher priority is not already being serviced. If an interrupt of equal or higher level priority is being serviced, the new interrupt will wait until it is finished before being serviced. If a lower priority level interrupt is being serviced, it will be stopped and the new interrupt serviced. When the new interrupt is finished, the lower priority level interrupt that was stopped will be completed.

Table 7.Interrupt Table

SOURCE	POLLING PRIORITY	REQUEST BITS	HARDWARE CLEAR?	VECTOR ADDRESS
X0	1	IE0	N (L) ¹ Y (T) ²	03H
ТО	2	TP0	Y	0BH
X1	3	IE1	N (L) Y (T)	13H
T1	4	TF1	Y	1BH
SP	5	RI, TI	N	23H
T2	6	TF2, EXF2	Ν	2BH

NOTES:

1. L = Level activated

2. T = Transition activated

		7	6	5	4	3	2	1	0
	IE (0A8H)	EA	—	ET2	ES	ET1	EX1	ET0	EX0
	_		Bit = 1 ena Bit = 0 dis	ables the i ables it.	nterrupt.				
BIT	SYMBOL	FUNC	TION						
IE.7	EA						disabled.		each inte
					0	0	enable bit.		
IE.6	—	Not im	plemente	d. Reserv	ed for futu	re use.			
IE.5	ET2	Timer	2 interrup	t enable b	it.				
IE.4	ES	Serial	Port interi	upt enabl	e bit.				
IE.3	ET1	Timer	1 interrup	t enable b	it.				
IE.2	EX1	Extern	al interru	ot 1 enable	e bit.				
IE.1	ET0	Timer	0 interrup	t enable b	it.				
IE.0	EX0	Extern	al interrup	ot 0 enable	e bit.				

Figure 10. IE Registers

80C51/87C51/80C52/87C52

	_	7	6	5	4	3	2	1	0
	IP (0B8H)		_	PT2	PS	PT1	PX1	PT0	PX0
				signs high signs lowe					
BIT	SYMBOL	FUNC	TION						
IP.7	_	Not im	plemente	d, reserve	d for futur	e use.			
IP.6	_	Not im	plemente	d, reserve	d for futur	e use.			
IP.5	PT2	Timer	2 interrup	t priority b	it.				
IP.4	PS	Serial	Port interr	upt priorit	y bit.				
IP.3	PT1	Timer	Timer 1 interrupt priority bit.						
IP.2	PX1	Extern	External interrupt 1 priority bit.						
IP.1	PT0	Timer	0 interrup	t priority b	it.				
IP.0	PX0	Extern	al interrup	ot 0 priority	/ bit.				SU00572

Figure 11. IP Registers

		7	6	5	4	3	2	1	0
IPH (B7H)		—	—	PT2H	PSH	PT1H	PX1H	PT0H	PX0H
				signs high signs lowe					
BIT	SYMBOL	FUNC	TION						
IPH.7	_	Not im	plemente	d, reserve	d for futur	e use.			
IPH.6	_	Not im	plemente	d, reserve	d for futur	e use.			
IPH.5	PT2H	Timer	2 interrup	t priority b	it high.				
IPH.4	PSH	Serial	Port interi	upt priorit	y bit high.				
IPH.3	PT1H	Timer	1 interrup	t priority b	it high.				
IPH.2	PX1H	External interrupt 1 priority bit high.							
IPH.1	PT0H	Timer 0 interrupt priority bit high.							
IPH.0	PX0H	Extern	al interrup	ot 0 priority	/ bit high.				SU010

Figure 12. IPH Registers

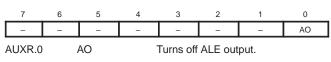
Reduced EMI

All port pins of the 8xC51 and 8xC52 have slew rate controlled outputs. This is to limit noise generated by quickly switching output signals. The slew rate is factory set to approximately 10 ns rise and fall times.

Reduced EMI Mode

The AO bit (AUXR.0) in the AUXR register when set disables the ALE output.

AUXR (8EH)



Dual DPTR

The dual DPTR structure (see Figure 13) enables a way to specify the address of an external data memory location. There are two 16-bit DPTR registers that address the external memory, and a single bit called DPS = AUXR1/bit0 that allows the program code to switch between them.

New Register Name: AUXR1#

- SFR Address: A2H
- Reset Value: xxx000x0B

AUXR1 (A2H)

7	6	5	4	3	2	1	0
-	-	-	LPEP	WUPD	0	-	DPS

Where:

DPS = AUXR1/bit0 = Switches between DPTR0 and DPTR1.

Select Reg	DPS
DPTR0	0
DPTR1	1

The DPS bit status should be saved by software when switching between DPTR0 and DPTR1.

80C51/87C51/80C52/87C52

Note that bit 2 is not writable and is always read as a zero. This allows the DPS bit to be quickly toggled simply by executing an INC DPTR instruction without affecting the WOPD or LPEP bits.

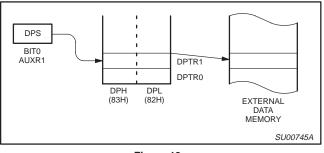


Figure 13.

DPTR Instructions

The instructions that refer to DPTR refer to the data pointer that is currently selected using the AUXR1/bit 0 register. The six instructions that use the DPTR are as follows:

INC DPTR	Increments the data pointer by 1
MOV DPTR, #data16	Loads the DPTR with a 16-bit constant
MOV A, @ A+DPTR	Move code byte relative to DPTR to ACC
MOVX A, @ DPTR	Move external RAM (16-bit address) to ACC
MOVX @ DPTR , A	Move ACC to external RAM (16-bit address)
JMP @ A + DPTR	Jump indirect relative to DPTR

The data pointer can be accessed on a byte-by-byte basis by specifying the low or high byte in an instruction which accesses the SFRs. See application note AN458 for more details.

80C51/87C51/80C52/87C52

ABSOLUTE MAXIMUM RATINGS1, 2, 3

PARAMETER	RATING	UNIT
Operating temperature under bias	0 to +70 or -40 to +85	°C
Storage temperature range	-65 to +150	°C
Voltage on EA/V _{PP} pin to V _{SS}	0 to +13.0	V
Voltage on any other pin to V _{SS}	-0.5 to +6.5	V
Maximum I _{OL} per I/O pin	15	mA
Power dissipation (based on package heat transfer limitations, not device power consumption)	1.5	W

NOTES:

 Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any conditions other than those described in the AC and DC Electrical Characteristics section of this specification is not implied.

This product includes circuitry specifically designed for the protection of its internal devices from the damaging effects of excessive static charge. Nonetheless, it is suggested that conventional precautions be taken to avoid applying greater than the rated maximum.
 Parameters are valid over operating temperature range unless otherwise specified. All voltages are with respect to V_{SS} unless otherwise

 Parameters are valid over operating temperature range unless otherwise specified. All voltages are with respect to V_{SS} unless otherwise noted.

AC ELECTRICAL CHARACTERISTICS

 $T_{amb} = 0^{\circ}C$ to +70°C or -40°C to +85°C

			CLOCK FREQUENCY RANGE –f		
SYMBOL	FIGURE	PARAMETER	MIN	MAX	UNIT
1/t _{CLCL}	29	Oscillator frequency Speed versions : S (16 MHz) U (33 MHz)	0 0	16 33	MHz MHz

DC ELECTRICAL CHARACTERISTICS

 $T_{amb} = 0^{\circ}C$ to +70°C or -40°C to +85°C, $V_{CC} = 2.7$ V to 5.5 V, $V_{SS} = 0$ V (16 MHz devices)

SYMBOL	DADAMETED	TEST					
STMBOL	PARAMETER	CONDITIONS	MIN	TYP ¹	MAX		
N/	Input low voltage ¹¹	4.0 V < V _{CC} < 5.5 V	-0.5		0.2 V _{CC} -0.1	V	
VIL	input low voltage "	2.7 V <v<sub>CC< 4.0 V</v<sub>	-0.5		0.7	V	
V _{IH}	Input high voltage (ports 0, 1, 2, 3, EA)		0.2 V _{CC} +0.9		V _{CC} +0.5	V	
V _{IH1}	Input high voltage, XTAL1, RST ¹¹		0.7 V _{CC}		V _{CC} +0.5	V	
V _{OL}	Output low voltage, ports 1, 2, 8	$V_{CC} = 2.7 V$ $I_{OL} = 1.6 mA^2$			0.4	V	
V _{OL1}	Output low voltage, port 0, ALE, PSEN ^{8, 7}	$V_{CC} = 2.7 V$ $I_{OL} = 3.2 mA^2$			0.4	V	
M	Output high voltage, ports 1, 2, 3 ³	V _{CC} = 2.7 V I _{OH} = -20 μA	V _{CC} – 0.7			V	
V _{OH}	Output high voltage, ports 1, 2, 3 °	V _{CC} = 4.5 V I _{OH} = -30 μA	V _{CC} – 0.7			V	
V _{OH1}	Output high voltage (port 0 in external bus mode), ALE^9 , \overline{PSEN}^3	$V_{CC} = 2.7 V$ $I_{OH} = -3.2 mA$	V _{CC} – 0.7			V	
IIL	Logical 0 input current, ports 1, 2, 3	V _{IN} = 0.4 V	-1		-50	μΑ	
I _{TL}	Logical 1-to-0 transition current, ports 1, 2, 3 ⁶	V _{IN} = 2.0 V See note 4			-650	μA	
ILI	Input leakage current, port 0	$0.45 < V_{IN} < V_{CC} - 0.3$			±10	μA	
I _{CC}	Power supply current (see Figure 21): Active mode @ 16 MHz Idle mode @ 16 MHz Power-down mode or clock stopped (see Figure 25 for conditions)	See note 5 T _{amb} = 0°C to 70°C T _{amb} = -40°C to +85°C		3	50 75	μΑ μΑ μΑ μΑ	
R _{RST}	Internal reset pull-down resistor		40		225	kΩ	
C _{IO}	Pin capacitance ¹⁰ (except EA)				15	pF	

NOTES:

1. Typical ratings are not guaranteed. The values listed are at room temperature, 5 V.

Capacitive loading on ports 0 and 2 may cause spurious noise to be superimposed on the Vols of ALE and ports 1 and 3. The noise is due to external bus capacitance discharging into the port 0 and port 2 pins when these pins make 1-to-0 transitions during bus operations. In the worst cases (capacitive loading > 100 pF), the noise pulse on the ALE pin may exceed 0.8 V. In such cases, it may be desirable to qualify ALE with a Schmitt Trigger, or use an address latch with a Schmitt Trigger STROBE input. IoL can exceed these conditions provided that no single output sinks more than 5 mA and no more than two outputs exceed the test conditions

3. Capacitive loading on ports 0 and 2 may cause the V_{OH} on ALE and PSEN to momentarily fall below the V_{CC} -0.7 specification when the address bits are stabilizing.

Pins of ports 1, 2 and 3 source a transition current when they are being externally driven from 1 to 0. The transition current reaches its maximum value when V_{IN} is approximately 2 V.

See Figures 22 through 25 for I_{CC} test conditions. 5.

Active mode: $I_{CC} = 0.9 \times FREQ. + 1.1 \text{ mA}$

- Idle mode: $I_{CC} = 0.18 \times FREQ. +1.01 \text{ mA}$; See Figure 21. 6. This value applies to $T_{amb} = 0^{\circ}C$ to $+70^{\circ}C$. For $T_{amb} = -40^{\circ}C$ to $+85^{\circ}C$, $I_{TL} = -750 \text{ }\mu\text{A}$.
- Load capacitance for port 0, ALE, and PSEN = 100 pF, load capacitance for all other outputs = 80 pF. 7.
- 8. Under steady state (non-transient) conditions, I_{OL} must be externally limited as follows:

Maximum IOL per port pin: 15 mA (*NOTE: This is 85°C specification.) 26 mA

- Maximum IOL per 8-bit port:
- Maximum total I_{OL} for all outputs: 71 mA

If IOL exceeds the test condition, VOL may exceed the related specification. Pins are not guaranteed to sink current greater than the listed test conditions.

9. ALE is tested to V_{OH1}, except when ALE is off then V_{OH} is the voltage specification.

- 10. Pin capacitance is characterized but not tested. Pin capacitance is less than 25 pF. Pin capacitance of ceramic package is less than 15 pF (except EA is 25 pF).
- 11. To improve noise rejection a nominal 100 ns glitch rejection circuitry has been added to the RST pin, and a nominal 15 ns glitch rejection circuitry has been added to the INTO and INT1 pins. Previous devices provided only an inherent 5 ns of glitch rejection.

80C51/87C51/80C52/87C52

DC ELECTRICAL CHARACTERISTICS

 $T_{amb} = 0^{\circ}C$ to +70°C or -40°C to +85°C, 33 MHz devices; 5 V ±10%; V_{SS} = 0 V

	DADAMETED	TEST				
SYMBOL	PARAMETER	CONDITIONS	MIN	TYP ¹	MAX	
V _{IL}	Input low voltage ¹¹	4.5 V < V _{CC} < 5.5 V	-0.5		0.2 V _{CC} -0.1	V
V _{IH}	Input high voltage (ports 0, 1, 2, 3, EA)		0.2 V _{CC} +0.9		V _{CC} +0.5	V
V _{IH1}	Input high voltage, XTAL1, RST ¹¹		0.7 V _{CC}		V _{CC} +0.5	V
V _{OL}	Output low voltage, ports 1, 2, 3 ⁸	V _{CC} = 4.5 V I _{OL} = 1.6mA ²			0.4	V
V _{OL1}	Output low voltage, port 0, ALE, PSEN 7, 8	$V_{CC} = 4.5 V$ $I_{OL} = 3.2mA^2$			0.4	V
V _{OH}	Output high voltage, ports 1, 2, 3 ³	V _{CC} = 4.5 V I _{OH} = -30µA	V _{CC} – 0.7			V
V _{OH1}	Output high voltage (port 0 in external bus mode), ALE ⁹ , PSEN ³	V _{CC} = 4.5 V I _{OH} = -3.2mA	V _{CC} – 0.7			V
IIL	Logical 0 input current, ports 1, 2, 3	V _{IN} = 0.4 V	-1		-50	μΑ
I _{TL}	Logical 1-to-0 transition current, ports 1, 2, 3 ⁶	V _{IN} = 2.0 V See note 4			-650	μA
ILI	Input leakage current, port 0	$0.45 < V_{IN} < V_{CC} - 0.3$			±10	μΑ
I _{CC}	Power supply current (see Figure 21): Active mode (see Note 5) Idle mode (see Note 5)	See note 5				
	Power-down mode or clock stopped (see Fig- ure 25 for conditions)	$T_{amb} = 0^{\circ}C \text{ to } 70^{\circ}C$ $T_{amb} = -40^{\circ}C \text{ to } +85^{\circ}C$		3	50 75	μΑ μΑ
R _{RST}	Internal reset pull-down resistor		40		225	kΩ
C _{IO}	Pin capacitance ¹⁰ (except EA)				15	pF

NOTES:

1. Typical ratings are not guaranteed. The values listed are at room temperature, 5 V.

Capacitive loading on ports 0 and 2 may cause spurious noise to be superimposed on the Vols of ALE and ports 1 and 3. The noise is due to external bus capacitance discharging into the port 0 and port 2 pins when these pins make 1-to-0 transitions during bus operations. In the worst cases (capacitive loading > 100 pF), the noise pulse on the ALE pin may exceed 0.8 V. In such cases, it may be desirable to qualify ALE with a Schmitt Trigger, or use an address latch with a Schmitt Trigger STROBE input. IOL can exceed these conditions provided that no single output sinks more than 5mA and no more than two outputs exceed the test conditions.

3. Capacitive loading on ports 0 and 2 may cause the V_{OH} on ALE and PSEN to momentarily fall below the V_{CC}-0.7 specification when the address bits are stabilizing.

Pins of ports 1, 2 and 3 source a transition current when they are being externally driven from 1 to 0. The transition current reaches its maximum value when V_{IN} is approximately 2 V.

- 5. See Figures 22 through 25 for I_{CC} test conditions.
- Active mode: I_{CC(MAX)} = 0.9 × FREQ. + 1.1 mA Idle mode: I_{CC(MAX)} = 0.18 × FREQ. +1.0 mA; See Figure 21.
 6. This value applies to T_{amb} = 0°C to +70°C. For T_{amb} = -40°C to +85°C, I_{TL} = -750 μA.

- 7.
- Load capacitance for port 0, ALE, and PSEN = 100 pF, load capacitance for all other outputs = 80 pF.
- Under steady state (non-transient) conditions, I_{OL} must be externally limited as follows: 8.
- Maximum IOL per port pin: 15 mA (*NOTE: This is 85°C specification.)
 - Maximum IOL per 8-bit port: 26 mA

Maximum total I_{OL} for all outputs: 71 mA

If IOL exceeds the test condition, VOL may exceed the related specification. Pins are not guaranteed to sink current greater than the listed test conditions.

- 9. ALE is tested to V_{OH1}, except when ALE is off then V_{OH} is the voltage specification.
- 10. Pin capacitance is characterized but not tested. Pin capacitance is less than 25 pF. Pin capacitance of ceramic package is less than 15 pF (except EA is 25 pF).
- 11. To improve noise rejection a nominal 100 ns glitch rejection circuitry has been added to the RST pin, and a nominal 15 ns glitch rejection circuitry has been added to the INTO and INTT pins. Previous devices provided only an inherent 5 ns of glitch rejection.

80C51/87C51/80C52/87C52

AC ELECTRICAL CHARACTERISTICS

 $T_{amb} = 0^{\circ}C$ to +70°C or -40°C to +85°C, $V_{CC} = +2.7$ V to +5.5 V, $V_{SS} = 0$ V^{1, 2, 3}

			16 MHz	CLOCK	VARIABLE CLOCK		
SYMBOL	FIGURE	PARAMETER	MIN	MAX	MIN	MAX	UNIT
1/t _{CLCL}	14	Oscillator frequency ⁵ Speed versions :S			3.5	16	MHz
t _{LHLL}	14	ALE pulse width	85		2t _{CLCL} -40		ns
t _{AVLL}	14	Address valid to ALE low	22		t _{CLCL} -40		ns
t _{LLAX}	14	Address hold after ALE low	32		t _{CLCL} -30		ns
t _{LLIV}	14	ALE low to valid instruction in		150		4t _{CLCL} -100	ns
t _{LLPL}	14	ALE low to PSEN low	32		t _{CLCL} -30		ns
t _{PLPH}	14	PSEN pulse width	142		3t _{CLCL} -45		ns
t _{PLIV}	14	PSEN low to valid instruction in		82		3t _{CLCL} -105	ns
t _{PXIX}	14	Input instruction hold after PSEN	0		0		ns
t _{PXIZ}	14	Input instruction float after PSEN		37		t _{CLCL} -25	ns
t _{AVIV} ⁴	14	Address to valid instruction in		207		5t _{CLCL} -105	ns
t _{PLAZ}	14	PSEN low to address float		10		10	ns
Data Memo	ory			-	•	•	
t _{RLRH}	15, 16	RD pulse width	275		6t _{CLCL} -100		ns
t _{WLWH}	15, 16	WR pulse width	275		6t _{CLCL} -100		ns
t _{RLDV}	15, 16	RD low to valid data in		147		5t _{CLCL} -165	ns
t _{RHDX}	15, 16	Data hold after RD	0		0		ns
t _{RHDZ}	15, 16	Data float after RD		65		2t _{CLCL} -60	ns
t _{LLDV}	15, 16	ALE low to valid data in		350		8t _{CLCL} -150	ns
t _{AVDV}	15, 16	Address to valid data in		397		9t _{CLCL} -165	ns
t _{LLWL}	15, 16	ALE low to RD or WR low	137	239	3t _{CLCL} -50	3t _{CLCL} +50	ns
t _{AVWL}	15, 16	Address valid to WR low or RD low	122		4t _{CLCL} -130		ns
t _{QVWX}	15, 16	Data valid to WR transition	13		t _{CLCL} -50		ns
t _{WHQX}	15, 16	Data hold after WR	13		t _{CLCL} -50		ns
t _{QVWH}	16	Data valid to WR high	287		7t _{CLCL} -150		ns
t _{RLAZ}	15, 16	RD low to address float		0		0	ns
t _{WHLH}	15, 16	RD or WR high to ALE high	23	103	t _{CLCL} -40	t _{CLCL} +40	ns
External C	lock		-		•	•	
t _{CHCX}	18	High time	20		20	t _{CLCL} -t _{CLCX}	ns
t _{CLCX}	18	Low time	20	1	20	t _{CLCL} -t _{CHCX}	ns
t _{CLCH}	18	Rise time	1	20		20	ns
t _{CHCL}	18	Fall time		20		20	ns
Shift Regis	ster	•	•	•	•	•	
t _{XLXL}	17	Serial port clock cycle time	750		12t _{CLCL}		ns
t _{QVXH}	17	Output data setup to clock rising edge	492	1	10t _{CLCL} -133		ns
t _{XHQX}	17	Output data hold after clock rising edge	8		2t _{CLCL} -117		ns
t _{XHDX}	17	Input data hold after clock rising edge	0	1	0		ns
t _{XHDV}	17	Clock rising edge to input data valid		492		10t _{CLCL} -133	ns

NOTES:

Parameters are valid over operating temperature range unless otherwise specified.
 Load capacitance for port 0, ALE, and PSEN = 100 pF, load capacitance for all other outputs = 80 pF.

Interfacing the 87C51, 80C51, 87C52, or 80C52 to devices with float times up to 45 ns is permitted. This limited bus contention will not cause damage to Port 0 drivers.

4. See application note AN457 for external memory interface.

5. Parts are guaranteed to operate down to 0 Hz. When an external clock source is used, the RST pin should be held high for a minimum of 20 µs for power-on or wakeup from power down.

80C51 8-bit microcontroller family 4 K/8 K OTP/ROM low voltage (2.7 V–5.5 V), low power, high speed (33 MHz), 128/256 B RAM

AC ELECTRICAL CHARACTERISTICS

 $T_{amb} = 0^{\circ}C$ to +70°C or -40°C to +85°C, $V_{CC} = 5 V \pm 10\%$, $V_{SS} = 0 V^{1, 2, 3}$

				E CLOCK ⁴			
				to f _{max}		CLOCK	
SYMBOL	FIGURE	PARAMETER	MIN	MAX	MIN	MAX	
t _{LHLL}	14	ALE pulse width	2t _{CLCL} -40		21		ns
t _{AVLL}	14	Address valid to ALE low	t _{CLCL} -25		5		ns
t _{LLAX}	14	Address hold after ALE low	t _{CLCL} -25				ns
t _{LLIV}	14	ALE low to valid instruction in		4t _{CLCL} –65		55	ns
t _{LLPL}	14	ALE low to PSEN low	t _{CLCL} -25		5		ns
t _{PLPH}	14	PSEN pulse width	3t _{CLCL} -45		45		ns
t _{PLIV}	14	PSEN low to valid instruction in		3t _{CLCL} -60		30	ns
t _{PXIX}	14	Input instruction hold after PSEN	0		0		ns
t _{PXIZ}	14	Input instruction float after PSEN		t _{CLCL} -25		5	ns
t _{AVIV}	14	Address to valid instruction in		5t _{CLCL} -80		70	ns
t _{PLAZ}	14	PSEN low to address float		10		10	ns
Data Memo	ry	-	•		-		
t _{RLRH}	15, 16	RD pulse width	6t _{CLCL} -100		82		ns
t _{WLWH}	15, 16	WR pulse width	6t _{CLCL} -100		82		ns
t _{RLDV}	15, 16	RD low to valid data in		5t _{CLCL} –90		60	ns
t _{RHDX}	15, 16	Data hold after RD	0		0		ns
t _{RHDZ}	15, 16	Data float after RD		2t _{CLCL} -28		32	ns
t _{LLDV}	15, 16	ALE low to valid data in		8t _{CLCL} -150		90	ns
t _{AVDV}	15, 16	Address to valid data in		9t _{CLCL} -165		105	ns
t _{LLWL}	15, 16	ALE low to RD or WR low	3t _{CLCL} -50	3t _{CLCL} +50	40	140	ns
t _{AVWL}	15, 16	Address valid to WR low or RD low	4t _{CLCL} -75		45		ns
t _{QVWX}	15, 16	Data valid to WR transition	t _{CLCL} -30		0		ns
tWHQX	15, 16	Data hold after WR	t _{CLCL} -25		5		ns
t _{QVWH}	16	Data valid to WR high	7t _{CLCL} -130		80		ns
t _{RLAZ}	15, 16	RD low to address float		0		0	ns
t _{WHLH}	15, 16	RD or WR high to ALE high	t _{CLCL} -25	t _{CLCL} +25	5	55	ns
External Clo	ock						
tснсх	18	High time	0.38t _{CLCL}	tCLCL-tCLCX			ns
tCLCX	18	Low time	0.38t _{CLCL}	t _{CLCL} -t _{CHCX}			ns
t _{CLCH}	18	Rise time		5			ns
t _{CHCL}	18	Fall time		5		1	ns
Shift Regist		1	-			1	
t _{XLXL}	17	Serial port clock cycle time	12t _{CLCL}		360		ns
t _{QVXH}	17	Output data setup to clock rising edge	10t _{CLCL} -133		167		ns
t _{XHQX}	17	Output data hold after clock rising edge	2t _{CLCL} -80		-		ns
t _{XHDX}	17	Input data hold after clock rising edge	0		0		ns
	17	Clock rising edge to input data valid		10t _{CLCL} -133	-	167	ns

NOTES:

1. Parameters are valid over operating temperature range unless otherwise specified.

2. Load capacitance for port 0, ALE, and PSEN = 100 pF, load capacitance for all other outputs = 80 pF.

3. Interfacing the 87C51, 80C51, 87C52 or 80C52 to devices with float times up to 45ns is permitted. This limited bus contention will not cause damage to Port 0 drivers.

4. Variable clock is specified for oscillator frequencies greater than 16 MHz to 33 MHz. For frequencies equal or less than 16 MHz, see 16 MHz "AC Electrical Characteristics", page 24.

5. Parts are guaranteed to operate down to 0 Hz. When an external clock source is used, the RST pin should be held high for a minimum of 20 μs for power-on or wakeup from power down.

EXPLANATION OF THE AC SYMBOLS

Each timing symbol has five characters. The first character is always 't' (= time). The other characters, depending on their positions, indicate the name of a signal or the logical status of that signal. The designations are:

- A Address
- $\mathsf{C}-\,\mathsf{Clock}$
- D Input data
- H Logic level high
- I Instruction (program memory contents)
- L Logic level low, or ALE

- P PSEN
- Q Output data
- R RD signal
- t Time
- V Valid
- W- WR signal
- X No longer a valid logic level
- Z Float

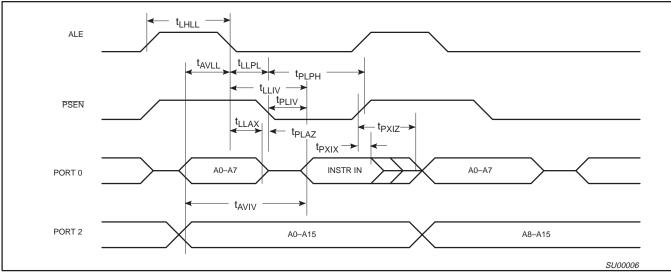


Figure 14. External Program Memory Read Cycle

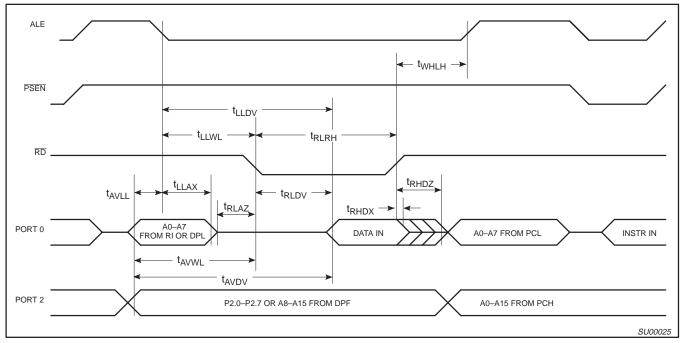


Figure 15. External Data Memory Read Cycle

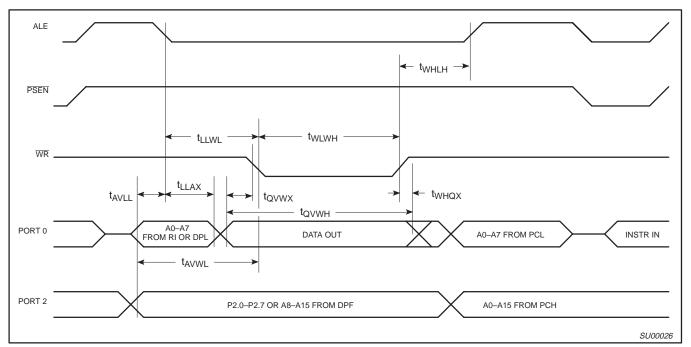


Figure 16. External Data Memory Write Cycle

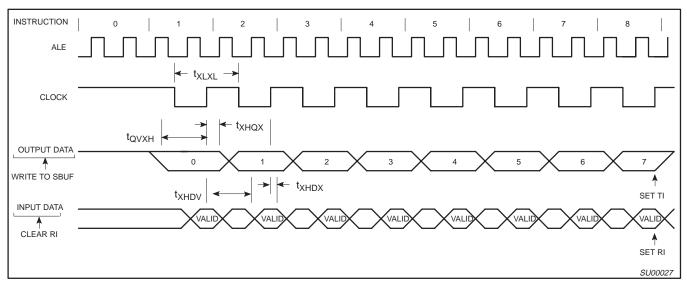


Figure 17. Shift Register Mode Timing

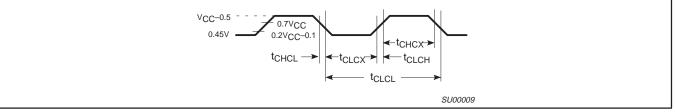


Figure 18. External Clock Drive

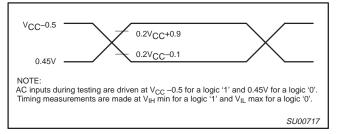
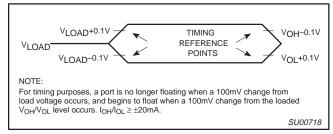


Figure 19. AC Testing Input/Output





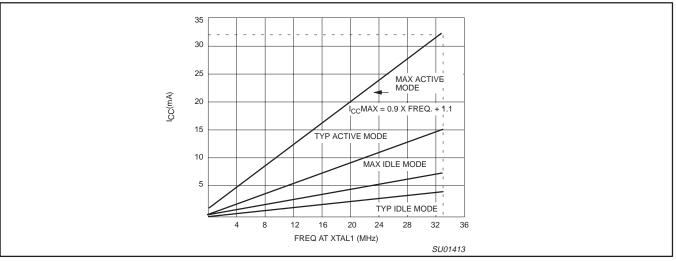
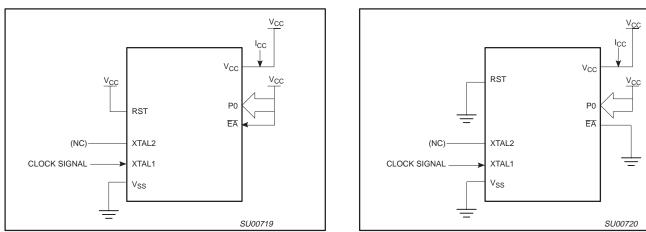
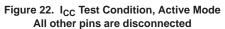
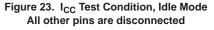
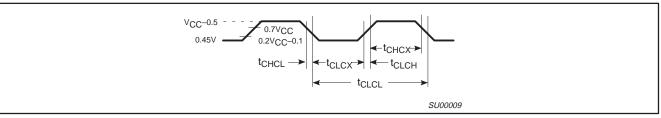


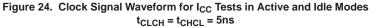
Figure 21. $I_{CC} \, vs. \, FREQ$ Valid only within frequency specifications of the device under test











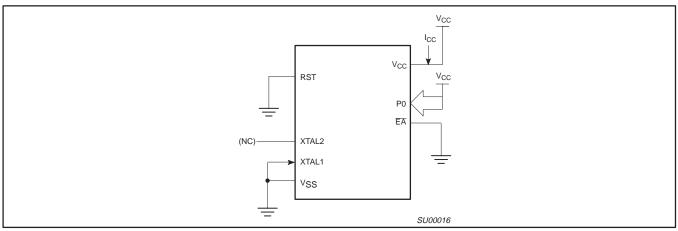


Figure 25. I_{CC} Test Condition, Power Down Mode All other pins are disconnected. V_{CC} = 2 V to 5.5 V

EPROM CHARACTERISTICS

These devices can be programmed by using a modified Improved Quick-Pulse ProgrammingTM algorithm. It differs from older methods in the value used for V_{PP} (programming supply voltage) and in the width and number of the ALE/PROG pulses.

The family contains two signature bytes that can be read and used by an EPROM programming system to identify the device. The signature bytes identify the device as being manufactured by Philips.

Table 8 shows the logic levels for reading the signature byte, and for programming the program memory, the encryption table, and the security bits. The circuit configuration and waveforms for quick-pulse programming are shown in Figures 26 and 27. Figure 28 shows the circuit configuration for normal program memory verification.

Quick-Pulse Programming

The setup for microcontroller quick-pulse programming is shown in Figure 26. Note that the device is running with a 4 to 6 MHz oscillator. The reason the oscillator needs to be running is that the device is executing internal address and program data transfers.

The address of the EPROM location to be programmed is applied to ports 1 and 2, as shown in Figure 26. The code byte to be programmed into that location is applied to port 0. RST, <u>PSEN</u> and pins of ports 2 and 3 specified in Table 8 are held at the 'Program Code Data' levels indicated in Table 8. The ALE/PROG is pulsed low 5 times as shown in Figure 27.

To program the encryption table, repeat the 5 pulse programming sequence for addresses 0 through 1FH, using the 'Pgm Encryption Table' levels. Do not forget that after the encryption table is programmed, verification cycles will produce only encrypted data.

To program the security bits, repeat the 5 pulse programming sequence using the 'Pgm Security Bit' levels. After one security bit is programmed, further programming of the code memory and encryption table is disabled. However, the other security bits can still be programmed.

Note that the \overline{EA}/V_{PP} pin must not be allowed to go above the maximum specified V_{PP} level for any amount of time. Even a narrow glitch above that voltage can cause permanent damage to the

80C51/87C51/80C52/87C52

device. The V_{PP} source should be well regulated and free of glitches and overshoot.

Program Verification

If security bits 2 and 3 have not been programmed, the on-chip program memory can be read out for program verification. The address of the program memory locations to be read is applied to ports 1 and 2 as shown in Figure 28. The other pins are held at the 'Verify Code Data' levels indicated in Table 8. The contents of the address location will be emitted on port 0. External pull-ups are required on port 0 for this operation.

If the 64 byte encryption table has been programmed, the data presented at port 0 will be the exclusive NOR of the program byte with one of the encryption bytes. The user will have to know the encryption table contents in order to correctly decode the verification data. The encryption table itself cannot be read out.

Reading the Signature Bytes

The signature bytes are read by the same procedure as a normal verification of locations 030H and 031H, except that P3.6 and P3.7 need to be pulled to a logic low. The values are: (030H) = 15H indicates manufactured by Philips (031H) = 92H indicates 87C51

Program/Verify Algorithms

Any algorithm in agreement with the conditions listed in Table 8, and which satisfies the timing specifications, is suitable.

Security Bits

With none of the security bits programmed the code in the program memory can be verified. If the encryption table is programmed, the code will be encrypted when verified. When only security bit 1 (see Table 9) is programmed, MOVC instructions executed from external program memory are disabled from fetching code bytes from the internal memory, EA is latched on Reset and all further programming of the EPROM is disabled. When security bits 1 and 2 are programmed, in addition to the above, verify mode is disabled. When all three security bits are programmed, all of the conditions above apply and all external program memory execution is disabled.

Encryption Array

64 bytes of encryption array are initially unprogrammed (all 1s).

MODE	RST	PSEN	ALE/PROG	EA/V _{PP}	P2.7	P2.6	P3.7	P3.6
Read signature	1	0	1	1	0	0	0	0
Program code data	1	0	0*	V _{PP}	1	0	1	1
Verify code data	1	0	1	1	0	0	1	1
Pgm encryption table	1	0	0*	V _{PP}	1	0	1	0
Pgm security bit 1	1	0	0*	V _{PP}	1	1	1	1
Pgm security bit 2	1	0	0*	V _{PP}	1	1	0	0
Pgm security bit 3	1	0	0*	V _{PP}	0	1	0	1

Table 8. EPROM Programming Modes

NOTES:

1. 0' = Valid low for that pin, 1' = valid high for that pin.

2. V_{PP} = 12.75 V ±0.25 V.

3. $V_{CC} = 5 \text{ V} \pm 10\%$ during programming and verification.

* ALE/PROG receives 5 programming pulses for code data (also for user array; 5 pulses for encryption or security bits) while V_{PP} is held at 12.75 V. Each programming pulse is low for 100 μs (±10 μs) and high for a minimum of 10 μs.

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80C51/87C51/80C52/87C52

Table 9. Program Security Bits for EPROM Devices

PRC	PROGRAM LOCK BITS ^{1, 2}				
	SB1	SB2	SB3	PROTECTION DESCRIPTION	
1	U	U	U	No Program Security features enabled. (Code verify will still be encrypted by the Encryption Ar programmed.)	
2	Ρ	U	U	MOVC instructions executed from external program memory are disabled from fetching code bytes from internal memory, EA is sampled and latched on Reset, and further programming of the EPROM is disabled.	
3	Р	Р	U	Same as 2, also verify is disabled.	
4	Р	Р	Р	Same as 3, external execution is disabled. Internal data RAM is not accessible.	

NOTES:

P – programmed. U – unprogrammed.
 Any other combination of the security bits is not defined.

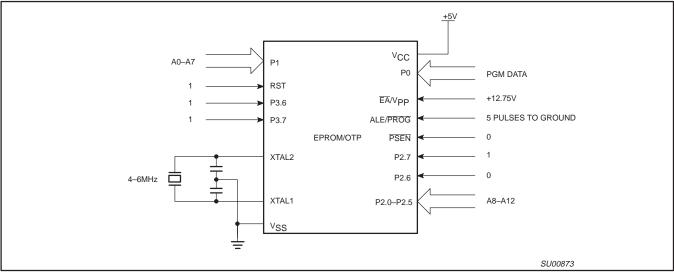


Figure 26. Programming Configuration

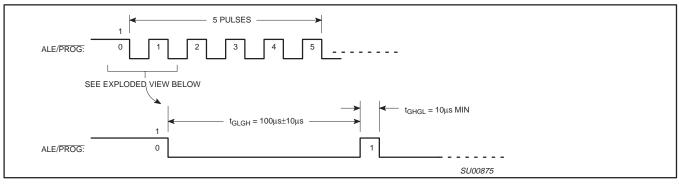


Figure 27. PROG Waveform

80C51/87C51/80C52/87C52

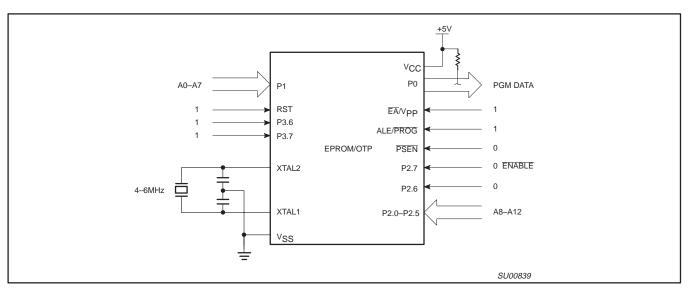


Figure 28. Program Verification

EPROM PROGRAMMING AND VERIFICATION CHARACTERISTICS

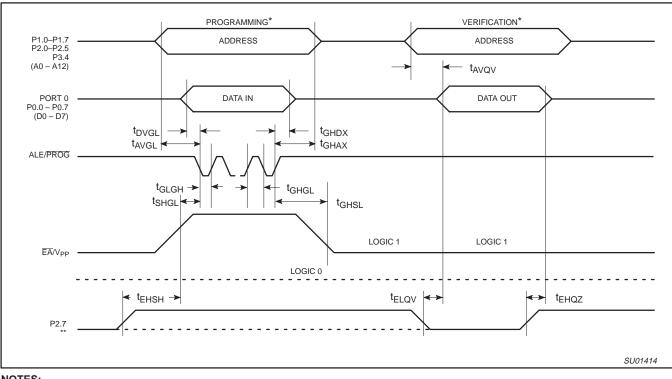
 $T_{amb} = 21^{\circ}C \text{ to } +27^{\circ}C, V_{CC} = 5 \text{ V} \pm 10\%, V_{SS} = 0 \text{ V} \text{ (See Figure 29)}$

SYMBOL	PARAMETER	MIN	MAX	UNIT
V _{PP}	Programming supply voltage	12.5	13.0	V
I _{PP}	Programming supply current		50 ¹	mA
1/t _{CLCL}	Oscillator frequency	4	6	MHz
t _{AVGL}	Address setup to PROG low	48t _{CLCL}		
t _{GHAX}	Address hold after PROG	48t _{CLCL}	1	
t _{DVGL}	Data setup to PROG low	48t _{CLCL}		
t _{GHDX}	Data hold after PROG	48t _{CLCL}		
t _{EHSH}	P2.7 (ENABLE) high to V _{PP}	48t _{CLCL}		
t _{SHGL}	V _{PP} setup to PROG low	10		μs
t _{GHSL}	V _{PP} hold after PROG	10		μs
t _{GLGH}	PROG width	90	110	μs
t _{AVQV}	Address to data valid		48t _{CLCL}	
t _{ELQZ}	ENABLE low to data valid		48t _{CLCL}	
t _{EHQZ}	Data float after ENABLE	0	48t _{CLCL}	
t _{GHGL}	PROG high to PROG low	10		μs

NOTE:

1. Not tested.

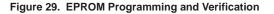
80C51 8-bit microcontroller family 4 K/8 K OTP/ROM low voltage (2.7 V-5.5 V), low power, high speed (33 MHz), 128/256 B RAM



NOTES:

FOR PROGRAMMING CONFIGURATION SEE FIGURE 26 FOR VERIFICATION CONDITIONS SEE FIGURE 28.

** SEE TABLE 8.



MASK ROM DEVICES

Security Bits

With none of the security bits programmed the code in the program memory can be verified. If the encryption table is programmed, the code will be encrypted when verified. When only security bit 1 (see Table 10) is programmed, MOVC instructions executed from external program memory are disabled from fetching code bytes

from the internal memory, EA is latched on Reset and all further programming of the EPROM is disabled. When security bits 1 and 2 are programmed, in addition to the above, verify mode is disabled.

Encryption Array

64 bytes of encryption array are initially unprogrammed (all 1s).

PROGRAM LOCK BITS ^{1, 2}		BITS ^{1, 2}	
	SB1	SB2	PROTECTION DESCRIPTION
1	U	U	No Program Security features enabled. (Code verify will still be encrypted by the Encryption Array if programmed.)
2	Р	U	MOVC instructions executed from external program memory are disabled from fetching code bytes from internal memory, \overline{EA} is sampled and latched on Reset, and further programming of the EPROM is disabled.

Table 10. Program Security Bits

NOTES:

1. P - programmed. U - unprogrammed.

2. Any other combination of the security bits is not defined.

80C51/87C51/80C52/87C52

80C51 ROM CODE SUBMISSION

When submitting ROM code for the 80C51, the following must be specified:

- 1. 4k byte user ROM data
- 2. 64 byte ROM encryption key
- 3. ROM security bits.

ADDRESS	CONTENT	BIT(S)	COMMENT
0000H to 0FFFH	DATA	7:0	User ROM Data
1000H to 103FH	KEY	7:0	ROM Encryption Key
1040H	SEC	0	ROM Security Bit 1
1040H	SEC	1	ROM Security Bit 2

Security Bit 1: When programmed, this bit has two effects on masked ROM parts:

1. External MOVC is disabled, and

2. EA is latched on Reset.

Security Bit 2: When programmed, this bit inhibits Verify User ROM.

NOTE: Security Bit 2 cannot be enabled unless Security Bit 1 is enabled.

If the ROM Code file does not include the options, the following information must be included with the ROM code.

For each of the following, check the appropriate box, and send to Philips along with the code:

Security Bit #1:	Enabled	□ Disabled
Security Bit #2:	□ Enabled	□ Disabled
Encryption:	🗆 No	□ Yes If Yes, must send key file.

80C52 ROM CODE SUBMISSION

When submitting ROM code for the 80C52, the following must be specified:

1. 8k byte user ROM data

- 2. 64 byte ROM encryption key
- 3. ROM security bits.

ADDRESS	CONTENT	BIT(S)	COMMENT
0000H to 1FFFH	DATA	7:0	User ROM Data
2000H to 203FH	KEY	7:0	ROM Encryption Key
2040H	SEC	0	ROM Security Bit 1
2040H	SEC	1	ROM Security Bit 2

Security Bit 1: When programmed, this bit has two effects on masked ROM parts:

1. External MOVC is disabled, and

2. EA is latched on Reset.

Security Bit 2: When programmed, this bit inhibits Verify User ROM.

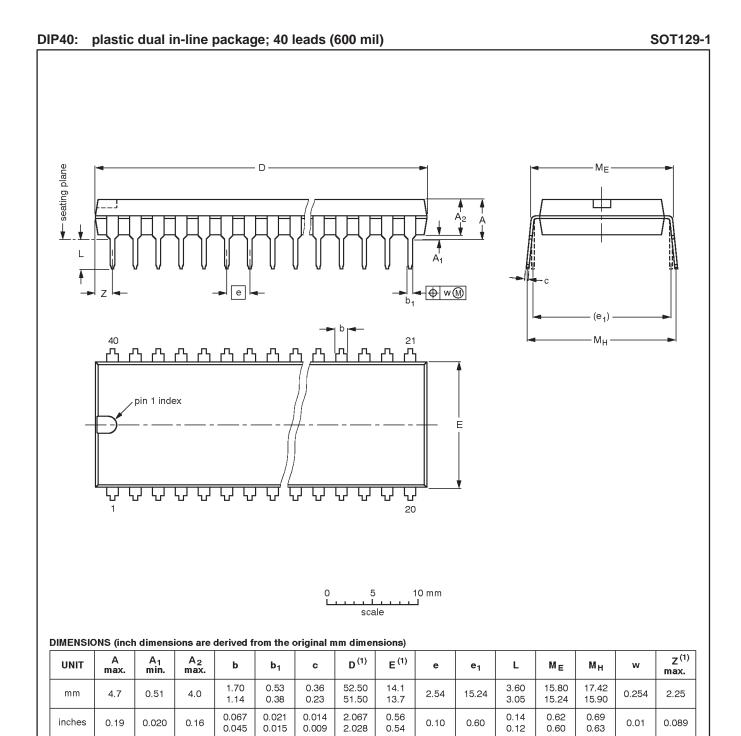
NOTE: Security Bit 2 cannot be enabled unless Security Bit 1 is enabled.

If the ROM Code file does not include the options, the following information must be included with the ROM code.

For each of the following, check the appropriate box, and send to Philips along with the code:

Security Bit #1:	Enabled	Disabl	ed
Security Bit #2:	Enabled	Disabl	ed
Encryption:	🗆 No	□ Yes	If Yes, must send key file.

80C51/87C51/80C52/87C52



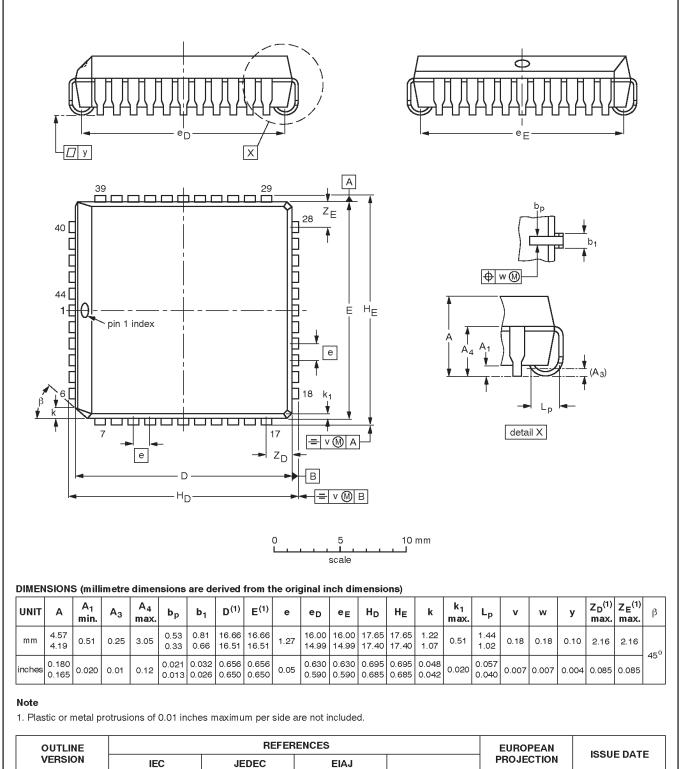
Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT129-1	051G08	MO-015	SC-511-40			-95-01-14 99-12-27

80C51/87C51/80C52/87C52





112E10

MO-047

SOT187-2

SOT187-2

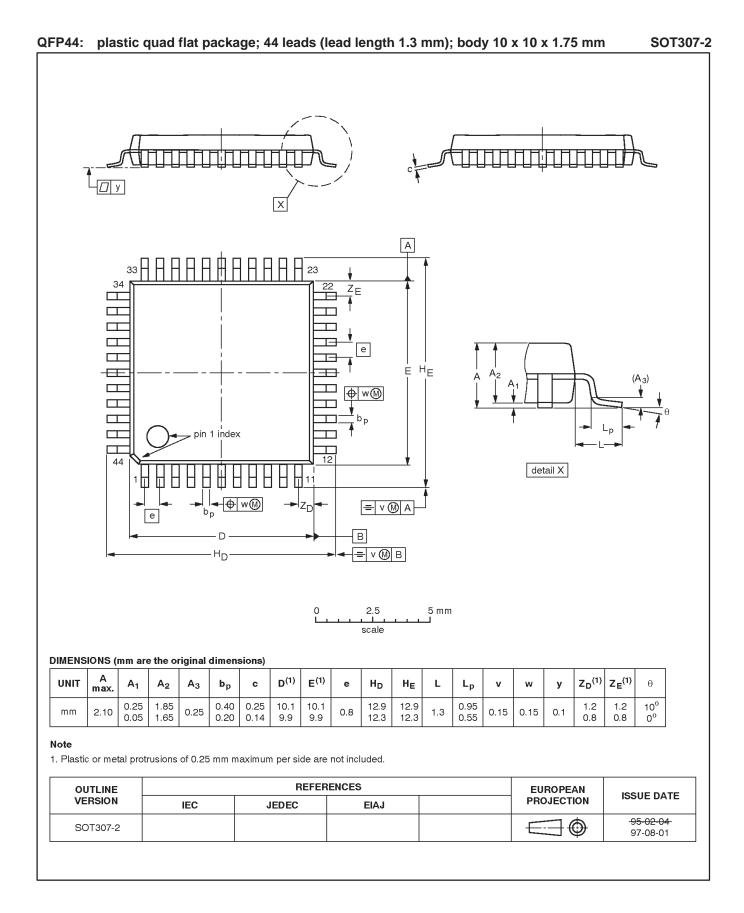
97-12-16

99-12-27

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80C51/87C51/80C52/87C52

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
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[1] Please consult the most recently issued datasheet before initiating or completing a design.

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